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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/699,127	10/30/2003	Hyun Woo Song	2013P115	4968
8791	7590 08/04/2005		EXAMINER	
BLAKELY SOKOLOFF TAYLOR & ZAFMAN 12400 WILSHIRE BOULEVARD SEVENTH FLOOR LOS ANGELES, CA 90025-1030			PRENTY, MARK V	
			ART UNIT	PAPER NUMBER
			2822	
			DATE MAILED: 08/04/2003	5

Please find below and/or attached an Office communication concerning this application or proceeding.

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	Application No.	Applicant(s)					
Office Action Occurrence	10/699,127	SONG ET AL.					
Office Action Summary	Examiner	Art Unit					
	MARK PRENTY	2822					
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the c	orrespondence address					
A SHORTENED STATUTORY PERIOD FOR REPLY THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a reply if NO period for reply is specified above, the maximum statutory period we Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	6(a). In no event, however, may a reply be tim within the statutory minimum of thirty (30) days ill apply and will expire SIX (6) MONTHS from cause the application to become ABANDONED	nely filed s will be considered timely. the mailing date of this communication. O (35 U.S.C. § 133).					
Status							
1) Responsive to communication(s) filed on 20 Ju	<u>ne 2005</u> .						
2a) ☐ This action is <b>FINAL</b> . 2b) ☑ This	action is non-final.						
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Disposition of Claims							
4) ☐ Claim(s) 1-17 is/are pending in the application. 4a) Of the above claim(s) is/are withdraw 5) ☐ Claim(s) is/are allowed. 6) ☐ Claim(s) 1-7,9-13 and 15 is/are rejected. 7) ☐ Claim(s) 3,8,14,16 and 17 is/are objected to. 8) ☐ Claim(s) are subject to restriction and/or							
Application Papers							
9)☐ The specification is objected to by the Examiner	9) The specification is objected to by the Examiner.						
10)☐ The drawing(s) filed on is/are: a)☐ acce	D)☐ The drawing(s) filed on is/are: a)☐ accepted or b)☐ objected to by the Examiner.						
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).							
	Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).  The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.						
Priority under 35 U.S.C. § 119							
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of:  1. Certified copies of the priority documents 2. Certified copies of the priority documents 3. Copies of the certified copies of the priority application from the International Bureau * See the attached detailed Office action for a list of	have been received. have been received in Application ity documents have been received (PCT Rule 17.2(a)).	on No ed in this National Stage					
Attachment(s)							
Notice of References Cited (PTO-892)	4) Interview Summary						
2) ☐ Notice of Draftsperson's Patent Drawing Review (PTO-948)  3) ☐ Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)  Paper No(s)/Mail Date <i>July 5, 2005</i> .	Paper No(s)/Mail Da 5) Notice of Informal Pa 6) Other:	te atent Application (PTO-152)					

Art Unit: 2822

This Office Action is in response to the amendment filed on June 20, 2005.

Claim 3 is objected to because "AI<sub>2</sub>O<sub>3</sub>," "AIN" and "AION" should read "AI<sub>2</sub>O<sub>3</sub>," "AIN" and "AION," respectively (see the specification at page 3, lines 13-15, and claim 3 as originally filed, for example, and note that the symbol for AIuminum is AI).

Claims 1, 3-7, 9, 11-13 and 15 are rejected under 35 U.S.C. 102(b) as being anticipated by Choquette et al. (already of record United States Patent 5,493,577 – hereafter Choquette).

With respect to independent claim 1, Choquette discloses a semiconductor optical device (see the entire patent, including the Fig. 2 disclosure) comprising: a first semiconductor layer 20 (the lower one) of a first conductivity type (see column 10, lines 4-14) which is formed on a semiconductor substrate 12 and includes one or more material layers (note the paragraph bridging columns 12-13); a second semiconductor layer 18 which is formed on the first semiconductor layer and includes one or more material layers; and a third semiconductor layer 20 (the upper one) of a second conductivity type (see column 10, lines 4-14) which is formed on the second semiconductor layer and includes one or more material layers (note the paragraph bridging columns 12-13), wherein one or more layers among the first semiconductor layer, the second semiconductor layer and the third semiconductor layer have a mesa structure, a lateral portion of at least one of the material layers constituting the first semiconductor layer, the second semiconductor layer, and the third semiconductor layer is recessed, and the recess is wholly filled with an oxide layer (i.e., layers 20 have oxidized portions, which is structurally tantamount to their having recesses wholly filled

Art Unit: 2822

with an oxide layer), and the first semiconductor layer and the third semiconductor layer serve as confinement-conducting regions (see column 10, lines 15-18, for example, and note that "carder" should apparently read "carrier").

Claim 1 is thus rejected under 35 U.S.C. 102(b) as being anticipated by Choquette.

With respect to dependent claim 3, Choquette's oxide layer is formed of Al<sub>2</sub>O<sub>3</sub> (i.e., oxidized aluminum - see column 9, lines 22-24).

Claim 3 is thus rejected under 35 U.S.C. 102(b) as being anticipated by Choquette.

With respect to dependent claim 4, when Choquette's first (lower) semiconductor layer 20 is a p-type semiconductor layer, the third (upper) semiconductor layer 20 is an n-type semiconductor layer and when the first semiconductor layer is an n-type semiconductor layer, the third semiconductor layer is a p-type semiconductor layer (see column 6, lines 46-54, together with column 10, lines 4-14).

Claim 4 is thus rejected under 35 U.S.C. 102(b) as being anticipated by Choquette.

With respect to dependent claim 5, Choquette's second semiconductor layer 18 is one of a p-type semiconductor layer, an n-type semiconductor layer, and an undoped semiconductor layer (see column 8, lines 17-25).

Claim 5 is thus rejected under 35 U.S.C. 102(b) as being anticipated by Choquette.

Art Unit: 2822

With respect to dependent claim 6, Choquette's second semiconductor layer 18 is a gain region.

Claim 6 is thus rejected under 35 U.S.C. 102(b) as being anticipated by Choquette.

With respect to dependent claim 7, Choquette's device further comprises at least one reflecting mirror 14 formed so as to be parallel with the first semiconductor layer through the third semiconductor layer such that output light is perpendicular to the first semiconductor layer through the third semiconductor layer (see Fig. 2).

Claim 7 is thus rejected under 35 U.S.C. 102(b) as being anticipated by Choquette.

With respect to independent claim 9, Choquette discloses a semiconductor optical device (see the entire patent, including the Fig. 2 disclosure) comprising: confinement-conducting regions having semiconductor layers 20 (see column 10, lines 15-18, for example, and note that "carder" should apparently read "carrier"), each of which includes one or more material layers (note the paragraph bridging columns 12-13); and a gain region 18 having a semiconductor layer, which is formed between the confinement-conducting regions and includes one or more material layers, wherein the confinement-conducting regions and the gain region have a mesa structure, and a lateral portion of at least one of the material layers constituting the semiconductor layers of the confinement-conducting regions and the gain region is recessed, and the recess is partially or wholly filled with an oxide layer, a nitride layer or a combination of them

Art Unit: 2822

(i.e., layers 20 have oxidized portions, which is structurally tantamount to their having recesses wholly filled with an oxide layer).

Claim 9 is thus rejected under 35 U.S.C. 102(b) as being anticipated by Choquette.

With respect to dependent claim 11, Choquette's oxide layer is formed of Al<sub>2</sub>O<sub>3</sub> (i.e., oxidized aluminum - see column 9, lines 22-24).

Claim 11 is thus rejected under 35 U.S.C. 102(b) as being anticipated by Choquette.

With respect to dependent claim 12, Choquette's semiconductor layers 20 constituting the confinement-conducting regions are one of a p-type semiconductor layer, an n-type semiconductor layer and a combination of them (see column 6, lines 46-54, together with column 10, lines 4-14).

Claim 12 is thus rejected under 35 U.S.C. 102(b) as being anticipated by Choquette.

With respect to dependent claim 13, Choquette's semiconductor layer 18 constituting the gain region is one of a p-type semiconductor layer, an n-type semiconductor layer, and an undoped semiconductor layer (see column 8, lines 17-25).

Claim 13 is thus rejected under 35 U.S.C. 102(b) as being anticipated by Choquette.

With respect to dependent claim 15, Choquette's device further comprises at least one reflecting mirror 14 formed so as to be parallel with the confinement-

conducting regions and the gain region such that output light is perpendicular to the confinement-conducting regions and the gain region (see Fig. 2).

Claim 15 is thus rejected under 35 U.S.C. 102(b) as being anticipated by Choquette.

Claim 2 is rejected under 35 U.S.C. 102(b) as anticipated by or, in the alternative, under 35 U.S.C. 103(a) as obvious over Choquette et al. (already of record United States Patent 5,493,577 – hereafter Choquette). Specifically, claim 2 depends on independent claim 1, which is rejected under 35 U.S.C. 102(b) as being anticipated by Choquette (see above). The above explanation of the rejection of independent claim 1 under 35 U.S.C. 102(b) as being anticipated by Choquette is hereby incorporated by reference into this rejection of dependent claim 2 under 35 U.S.C. 102(b) as anticipated by or, in the alternative, under 35 U.S.C. 103(a) as obvious over Choquette. The difference, therefore, between device claim 2 and Choquette's device is a process one (i.e., their oxide layers are formed by atomic layer deposition and oxidation, respectively). Insofar as claim 2's oxide layer appears to be structurally the same as or similar to Choquette's oxide layer (in view of their similar use, for example), claim 2 is rejected under 35 U.S.C. 102(b) as anticipated by or, in the alternative, under 35 U.S.C. 103(a) as obvious over Choquette. See MPEP 2113.

Claim 10 is rejected under 35 U.S.C. 102(b) as anticipated by or, in the alternative, under 35 U.S.C. 103(a) as obvious over Choquette et al. (already of record United States Patent 5,493,577 – hereafter Choquette). Specifically, claim 10 depends on independent claim 9, which is rejected under 35 U.S.C. 102(b) as being anticipated

Art Unit: 2822

by Choquette (see above). The above explanation of the rejection of independent claim 9 under 35 U.S.C. 102(b) as being anticipated by Choquette is hereby incorporated by reference into this rejection of dependent claim 10 under 35 U.S.C. 102(b) as anticipated by or, in the alternative, under 35 U.S.C. 103(a) as obvious over Choquette. The difference, therefore, between device claim 10 and Choquette's device is a process one (i.e., their oxide layers are formed by atomic layer deposition and oxidation, respectively). Insofar as claim 10's oxide layer appears to be structurally the same as or similar to Choquette's oxide layer (in view of their similar use, for example), claim 10 is rejected under 35 U.S.C. 102(b) as anticipated by or, in the alternative, under 35 U.S.C. 103(a) as obvious over Choquette. See MPEP 2113.

Claims 8, 14, 16 and 17 are objected to as being dependent upon a rejected base claim, but would be allowable over the prior art of record if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

The applicants' arguments are somewhat moot in view of the restatement of the rejections based on Choquette. The still relevant arguments are addressed below.

The applicants' argument (on page 6): "However, because the control layer 20 does not include one or more material layers as recited in Claim [1], the control layers 20 also cannot anticipate the first and the third semiconductor layers," is unclear. Specifically, as explained in the restatement of the rejection of claim 1, claim 1's first and third semiconductor layers read on Choquette's Fig. 2 control layers 20, which clearly do "include one or more material layers," and the applicants' argument to the

Art Unit: 2822

contrary is unclear. If the applicants are arguing that Choquette's control layers 20 do

not include more than one layer, such is incorrect. See Choquette at the paragraph

bridging columns 12-13.

The applicants' argument (on page 6): "However, Choquette does not teach a

recess partially or wholly filled with an oxide layer, a nitride layer, or a combination of

them as recited in Claim 1. Choquette fails to even mention a filling process, or a

recess filled with an oxide layer or a nitride layer," is incorrect. Specifically, as

explained in the restatement of the rejection of claim 1, Choquette's layers 20 have

oxidized portions, which is structurally tantamount to their having recesses wholly filled

with an oxide layer.

Registered practitioners can telephone the examiner at (571) 272-1843. Any

voicemail message left for the examiner must include the name and registration number

of the registered practitioner calling, and the Application/Control (Serial) Number.

Technology Center 2800's general telephone number is (571) 272-2800.

Mark V. Prenty
Primary Examiner

Page 8